

**INVENTORSHIP DECLARATION BY JOINT INVENTORS**

I HEREBY DECLARE THAT:

My residence, mailing address, and citizenship are stated next to my name in PART A hereof.

I believe I am the original, first, and joint inventor of the subject matter which is claimed and for which a patent is sought on the invention entitled

**STACKED MICROFEATURE DEVICES AND ASSOCIATED METHODS**

the specification of which:

- is attached hereto.
- was filed on \_\_\_\_\_ as Application Serial No. \_\_\_\_\_ and was amended on \_\_\_\_\_ (if applicable).

I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the examination of this application in accordance with 37 CFR §1.56, including, for continuation-in-part applications, material information which became available between the filing date of the prior application and the national or PCT international filing date of the continuation-in-part application.

I hereby claim priority benefits under 35 USC §119(a)-(d) or (f), §172, or §365(a)-(b) of any foreign or international application(s) for patent or inventor's certificate listed in PART B hereof and have also identified in PART B hereof any such foreign or international application having a filing date before that of the application of which priority is claimed.

I hereby declare that all statements made herein of my knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon. I understand that the execution of this document does not in itself establish an attorney-client relationship between the undersigned and Perkins Coie LLP, or any of its attorneys.

See page 2 attached, signed, and made a part hereof.

## INVENTORSHIP DECLARATION BY JOINT INVENTORS

### PART A: INVENTOR INFORMATION AND SIGNATURE

Full name of FIRST inventor: Mung Suan Heng

Citizenship: Singaporean Mailing Address: 515, Dunman Road, #08-02  
Singapore 439204

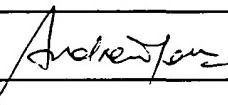
Residence (if different): \_\_\_\_\_

Inventor's Signature:  Date: 18 Aug 2003

Full name of SECOND inventor: Kok Chua Tan

Citizenship: Singaporean Mailing Address: Blk. 358, #04-354, Hougang Avenue 5  
Singapore 530358

Residence (if different): \_\_\_\_\_

Inventor's Signature:  Date: 18 Aug 2003

Full name of THIRD inventor: Vince Chan Seng Leong

Citizenship: Malaysian Mailing Address: 93, Yishun Street 81, #08-05  
Singapore 768451

Residence (if different): \_\_\_\_\_

Inventor's Signature:  Date: 18 Aug 2003

Full name of FOURTH inventor: Mark S. Johnson

Citizenship: USA Mailing Address: 3815 Baja Way  
Boise, Idaho 83709

Residence (if different): \_\_\_\_\_

Inventor's Signature: \_\_\_\_\_ Date: \_\_\_\_\_

**INVENTORSHIP DECLARATION BY JOINT INVENTORS**

**PART B: CLAIM TO PRIORITY OF FOREIGN APPLICATION(S) UNDER  
35 U.S.C. §119(a)-(d) or (f), §172, or §365(a)-(b)**

Country	App. No.	Filing Date	Priority Not Claimed
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Citizenship: Sinagaporean Mailing Address: 515, Dunman Road, #08-02  
Singapore 439204

Residence (if different): \_\_\_\_\_

Inventor's Signature: \_\_\_\_\_ Date: \_\_\_\_\_

Full name of SECOND inventor: Kok Chua Tan

Citizenship: Singaporean Mailing Address: Blk. 358, #04-354, Hougang Avenue 5  
Singapore 530358

Residence (if different): \_\_\_\_\_

Inventor's Signature: \_\_\_\_\_ Date: \_\_\_\_\_

Full name of THIRD inventor: Vince Chan Seng Leong

Citizenship: Malaysian Mailing Address: 93, Yishun Street 81, #08-05  
Singapore 768451

Residence (if different): \_\_\_\_\_

Inventor's Signature: \_\_\_\_\_ Date: \_\_\_\_\_

Full name of FOURTH inventor: Mark S. Johnson

Citizenship: USA Mailing Address: 3815 Baja Way  
Boise, Idaho 83709

Residence (if different): \_\_\_\_\_

Inventor's Signature: Mark S. Johnson Date: 8/27/2003

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35 U.S.C. §119(a)-(d) or (f), §172, or §365(a)-(b)**

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